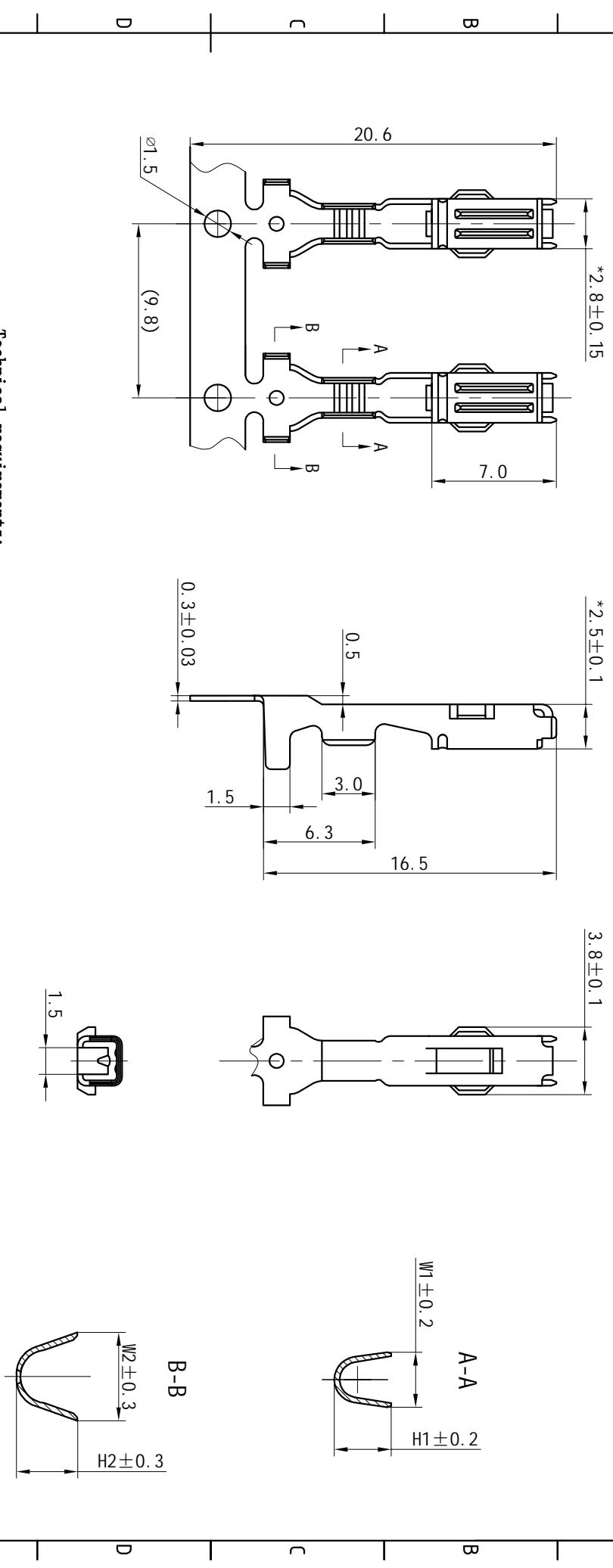


MARK	ECN	DESCRIPTION	DWN.	DATE



## Technical requirements:

- technical requirements.

  - Stamping surface are not allowed to have obvious scratch, crack, deformation, etc Clear stamping defects, chamfering, stamping feng is less than 0.02 mm
  - No note fillet R for R0.2 to R0.5 mm
  - Product embossing and stiffener depth of 0.08 to 0.1 mm
  - “\*” as the important features, “!” As the key features.
  - Not note size tolerance of GB/T15055-2007 - m.

SURFACE TREATMENT: TIN-PLATED  
 MATERIAL: BRASS  
  
 乐清市奥海电气有限公司  
 Yueqing Ahai Electric Co., Ltd.